Cities worldwide are entering an era, where residents and environments are tightly connected through intelligent technologies for the greater prosperity. In this paradigm, connectivity is the platform and foundation. Current communication and networking solutions cannot support the scalable, heterogamous, interoperable, energy-efficient, error-free, high-speed, and intelligent connectivity for smart cities. This workshop aims at bringing together researchers, developers, and practitioners to propose visions, insights and solutions to smart cities from the communication and networking perspectives. We welcome recent advances in next generation communications and networking systems, algorithms, theories, protocols, applications, experiments, and testbeds.

**Topics:**
- Wireless LAN, ad hoc, mesh Networks
- Sensor networks and pervasive Computing
- Security, privacy in communication
- Internet of Things (IoT)
- Social network computing
- City-wide smart communication system
- Software defined network (SDN)
- Vehicle to infrastructure communication (V2I)
- Network function virtualization
- Machine to machine communication (M2M)
- Vehicle to vehicle communication (V2V)
- Interference management
- Scalable wireless solutions
- Mobility handling
- Energy cost control
- AI enabled smart communication
- Modern networking schemes based on emerging communication technologies, WiFi 6, 5G, 6LowPAN, Green Communication, visible light communication, Thread, Sigfox, Neul, et al

**Important Dates:**
- Submission Due: March 5th, 2021
- Notification: April 23rd, 2021
- Camera-ready: April 30th, 2021
- Workshop: July 22, 2021

**TPC Chairs:**
- Shuhui Yang, Purdue University Northwest, USA
- Besma Smida, University of Illinois at Chicago, USA

**TPC members:**
- Bo Luo, The University of Kansas, USA
- Tae-Hoon Kim, Purdue University Northwest, USA
- Hamza Souri, University of Illinois at Chicago, USA
- Mina Guirguis, Texas State University, USA
- Wei Li, Chinese Academy of Sciences, China
- Xuefeng Xi, Suzhou Uni. of Science and Tech, China
- Yu Chen, Binghamton University, USA
- Lin Cai, Illinois Institute of Technology, USA
- Alexander Schwing, University of Illinois Urbana-Champaign, USA